

# **Product Compliance Declaration**

Please see <u>www.molex.com</u> for the most up-to-date information.

Contact Information					
Name	Molex Product Compliance	E-Mail	Product.Compliance@molex.com		
Part Inform	ation				
Part Number	0346910203	Part Weight	8.703G		
Part Name	STAC64 RA HDR 20 CKT GRN POL D TRAY				

## **Product Composition**

Name	Туре	CAS Number	CAS Number Proportion (% Total)	
STAC64 RA HDR 20 CKT GRN POL D TRAY	Assembly		100	8.703
STAC64 RA HDR HOUSING 20 CKT GRN POL D	Component		73.1127	6.363
PS GF GREEN	Material		73.1127	6.363
PS	Substance		42.9982	3.742131
GF-Fibre	Substance		21.7956	1.896868
Boric acid	Substance	10043-35-3	0.0355	0.003086
Benzene, ethenyl-, polymer with 1,3-butadiene, hydrogenated	Substance	66070-58-4	4.7108	0.409981
Further Additives, not to declare	Substance	system	2.5175	0.219097
Pigment portion, not to declare	Substance	system	1.0552	0.091837
0.64 X 34.93 SQ PIN BRASS REFLOW SN	Component		14.3629	1.25
SQ WIRE C26000 PL 0.625 X 0.625	Material		14.3629	1.25
Cartridge Brass 70% Unplated	Material		14.0679	1.224325
Copper	Substance	7440-50-8	9.8475	0.857028

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Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Zinc (metal)	Substance	7440-66-6	4.2204	0.367298
Copper Plating	Material		0.0282	0.002453
Copper	Substance	7440-50-8	0.0282	0.002453
Tin Plating	Material		0.1541	0.013411
Tin	Substance	7440-31-5	0.1541	0.013411
Nickel Plating	Material		0.1127	0.009811
Nickel	Substance	7440-02-0	0.1127	0.00981
Further Additives, not to declare	Substance	system	1E-05	1E-06
0.64 X 29.86 SQ PIN BRASS REFLOW SN	Component		11.3754	0.99
SQ WIRE C26000 PL 0.625 X 0.625	Material		11.3754	0.99
Cartridge Brass 70% Unplated	Material		11.1417	0.969665
Copper	Substance	7440-50-8	7.7992	0.678766
Zinc (metal)	Substance	7440-66-6	3.3425	0.2909
Copper Plating	Material		0.0223	0.001942
Copper	Substance	7440-50-8	0.0223	0.001942
Tin Plating	Material		0.122	0.010622
Tin	Substance	7440-31-5	0.122	0.010622
Nickel Plating	Material		0.0893	0.007771
Nickel	Substance	7440-02-0	0.0893	0.00777
Further Additives, not to declare	Substance	system	9E-06	8E-07
PIN ALIGNMENT PLATE-20CKT STAC64	Component		1.149	0.1
PET ST MYLAR 0.25 X 31.94	Material		1.149	0.1
Polyethylene terephthalate	Substance	25038-59-9	1.118	0.0973
Further Additives, not to declare	Substance	system	0.031	0.0027

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## **ROHS** Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

#### **Contained Substances Exceeding Threshold**

None

#### Exemptions

None

## **REACH-SVHC** Declaration Information

Regulatory Revision D(2020)9139-DC (19 Jan 2021)

## **Contained Substances Exceeding Threshold**

None

# **GADSL** Declaration Information

Regulatory Revision GADSL imported from IMDS

#### **Contained Substances Exceeding Threshold**

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Boric acid	PS GF GREEN	*Note	200	Yes
lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	150	Yes
lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes
copper	e-plate Cu (electrodeposited Copper Coatings)	*Note	999,625	Yes
glass, oxide, chemicals	PS GF GREEN	*Note	330,000	Yes
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes

\*Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

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Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

#### Exemptions

Part Name	Exemption		
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits		
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits		
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/ cm2/week)		

# **HFLH Declaration Information**

Regulatory Revision IEC 61249-2-21

#### **Contained Substances Exceeding Threshold**

None

# **China ROHS Declaration Information**

Part Number Part Name	0346910203 STAC64 RA HDR 20 CKT GRN POL D TRAY						
Part Informatio	n		Haz	zardous S	Substance	s	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
STAC64 RA HDR 20 CKT GRN POL D TRAY		0	0	0	0	0	0
STAC64 RA HDR HOUSING 20 CKT GRN POL D		0	0	0	0	0	0
0.64 X 34.93 SQ PIN BRASS REFLOW SN		0	0	0	0	0	0
0.64 X 29.86 SQ PIN BRASS REFLOW SN		0	0	0	0	0	0
PIN ALIGNMENT PLATE-20CKT STAC64		0	0	0	0	0	0

# **Process Information**

Component Plating / Surface Finish	MSn-RNi
Termination Base Alloy	Brass
Solder Alloy	N/A
Process Capability	WAVE

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Maximum Exposure Time (seconds)	040
Maximum Process Temperature (C)	260
Maximum Cycles at Reflow Temperature	003
J-STD-020 Moisture Sensitivity Level	N/A

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